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## BIB DATA SHEET

CONFIRMATION NO. 6557

<b>SERIAL NUMBER</b> 10/815,103	<b>FILING or 371(c) DATE</b> 03/31/2004 <b>RULE</b>	<b>CLASS</b> 257	<b>GROUP ART UNIT</b> 2826	<b>ATTORNEY DOCKET NO.</b> YOR920030190US1
<b>APPLICANTS</b> Keith E. Fogel, Hopewell Junction, NY; Balaram Ghosal, Fishkill, NY; Sung K. Kang, Chappaqua, NY; Stephen Kilpatrick, Olney, MD; Paul A. Lauro, Brewster, NY; Henry A. Nye III, Brookfield, CT; Da-Yuan Shih, Poughkeepsie, NY; Donna S. Zupanski-Nielsen, Yorktown Heights, NY;				
<b>** CONTINUING DATA *****</b> <b>** FOREIGN APPLICATIONS *****</b> <b>** IF REQUIRED, FOREIGN FILING LICENSE GRANTED **</b> 06/10/2004				
Foreign Priority claimed <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No 35 USC 119(a-d) conditions met <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No Verified and /LEONARDO ANDUJAR/ Acknowledged Examiner's Signature _____	<input type="checkbox"/> Met after Allowance Initials _____	<b>STATE OR COUNTRY</b> NY	<b>SHEETS DRAWINGS</b> 6	<b>TOTAL CLAIMS</b> 46
<b>INDEPENDENT CLAIMS</b> 8				
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<b>TITLE</b> Interconnections for flip-chip using lead-free solders and having reaction barrier layers				
<b>FILING FEE RECEIVED</b> 1828	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:		<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of time) <input type="checkbox"/> 1.18 Fees (Issue) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit	